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The invention relates to a method for producing a protective covering for a component provided on a substrate (102), according to which at least one sacrificial structure is produced on the substrate (102). The sacrificial structure covers at least one region of the substrate (102) that surrounds the component. Afterwards, a polymer layer (106) is deposited that surrounds the at least one sacrificial structure. An opening (108) is made inside the polymer layer (106) in order to expose a section of the sacrificial structure. The sacrificial structure is then removed, whereupon the opening (108) made in the polymer layer (106) is closed.

